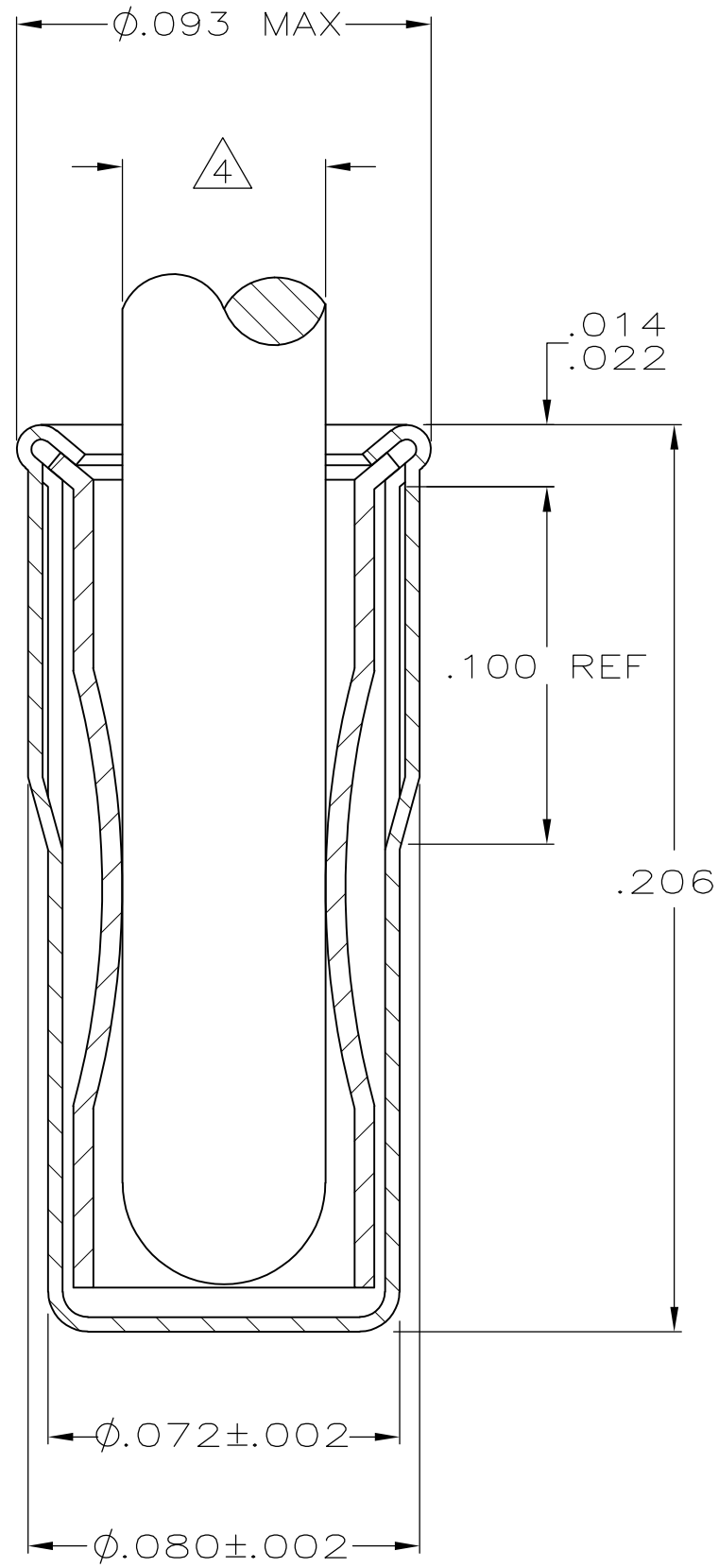
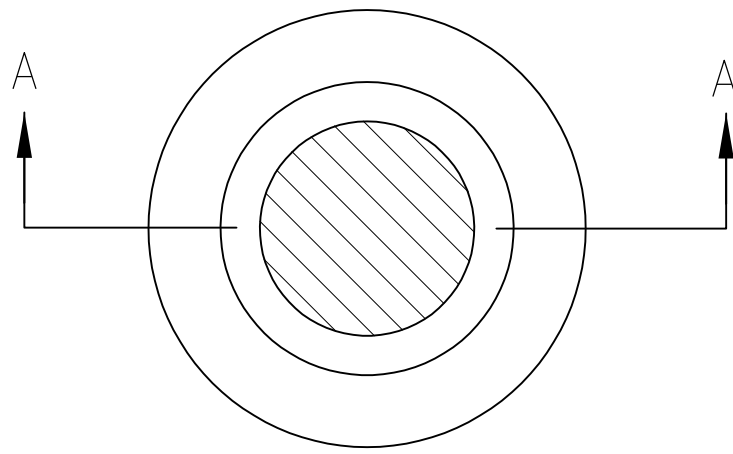
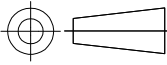


LOC	DIST	REVISIONS				
AG	53	P	LTR	DESCRIPTION	DATE	DWN
			01	REVISED PER ECO-08-021128	02SEP08	APVD



SECTION A-A

- 1 PLATING:
SPRING:
NICKEL UNDERPLATING ALL OVER, MATING SURFACES PLATED TO MEET PERFORMANCE REQUIREMENTS OF TYCO ELECTRONICS PRODUCT SPECIFICATION 108-14008.
EYELET:
TIN PLATE PER ASTM B 545 .000100 MIN THICK
2. RECOMMENDED HOLE SIZES PLATED OR UNPLATED:
HAND OR MACHINE INSERTION; .075-.078.
3. TO INSURE PROPER SPRING TENSION DO NOT EXCEED A .002 DIFFERENCE IN PIN DIA WHEN CHANGING TO A SMALLER PIN.
- 4 RECOMMENDED PIN DIA .040.
- 5 MATERIAL:
SPRING: BERYLLIUM COPPER PER ASTM B 194
EYELET: COPPER PER ASTM B 152

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN	G. ATTADIA	20APR2005	 Tyco Electronics Corporation Harrisburg, PA 17105-3608	
		CHK	J. HAVENER	20APR2005		
		APVD	J. HAVENER	20APR2005		
		PRODUCT SPEC	108-14008	NAME	ASSEMBLY, SOCKET, SPRING, MINIATURE SERIES 4	
DIMENSIONS: INCHES		TOLERANCES UNLESS OTHERWISE SPECIFIED:		APPLICATION SPEC	114-13152	RESTRICTED TO
		0 PLC ± - 1 PLC ± - 2 PLC ± - 3 PLC ± .008 4 PLC ± - ANGLES ± -		WEIGHT	-	-
MATERIAL		FINISH		SCALE	NTS	SHEET 1 of 1
5		1		CUSTOMER DRAWING	5645508	REV 01